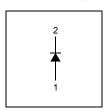


BAT54HT1G





Connection Diagram



Small Signal Diode

Absolute Maximum Ratings * T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	30	V
I _{F(AV)}	Average Rectified Forward Current	200	mA
I _{FSM}	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second	600	mA
T _{STG}	Storage Temperature Range	-65 to +150	°C
T _J	Operating Junction Temperature	-55 to +150	°C

^{*} These ratings are limiting values above which the serviceability of the diode may be impaired.

Thermal Characteristics

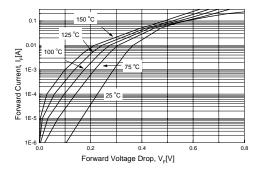
Symbol	Parameter	Value	Units	
P _D	Power Dissipation	200	mW	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	600	°C/W	

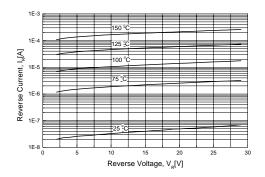
$\textbf{Electrical Characteristics} \quad \textbf{T}_{A} = 25^{\circ}\text{C unless otherwise noted}$

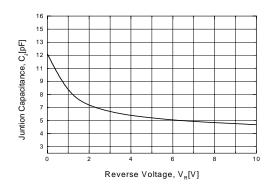
Symbol	Parameter	Test Conditions	Min.	Max.	Units
V _R	Breakdown Voltage	$I_R = 10\mu A$	30		V
V _F	Forward Voltage	I _F = 0.1mA		240	mV
		$I_F = 1.0 \text{mA}$		320	mV
		I _F = 10mA		400	mV
		$I_F = 30 \text{mA}$		500	mV
		I _F = 100mA		0.8	V
I _R	Reverse Leakage	V _R = 25V		2.0	μΑ
C _T	Total Capacitance	$V_R = 1V$, $f = 1.0MHz$		10	pF
t _{rr}	Reverse Recovery Time	$I_F = I_R = 10 \text{mA}, I_{RR} = 1.0 \text{mA},$ $R_1 = 100 \Omega$		5.0	ns
-	'	IX ·		_	

These ratings are based on a maximum junction temperature of 150 degrees C.
 These are steady limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

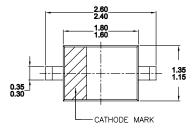
Typical Characteristics

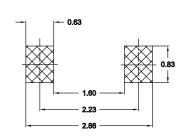


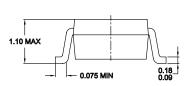


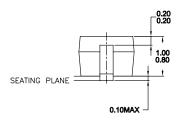


SOD-323









NOTES: UNLESS OTHERWISE SPECIFIED

A) THIS PACKAGE CONFORMS TO EIAJ SC76

B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DIMENSIONS ARE EXCLUSIVE OF BURRS,
MOLD FLASH, AND TIE BAR EXTRUSIONS.
D) DIMENSIONS AND TOLERANCES PER
ASME Y14.5M-1994

Dimensions in Millimeters

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